



# SPECIFICATION

At  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{DD} = +5\text{V}$ ,  $V_{SS} = -5\text{V}$ ,  $V_{REFH} = +2.5\text{V}$ ,  $V_{REFL} = -2.5\text{V}$ , unless otherwise noted.

PARAMETER	CONDITIONS	DAC7624P, U DAC7625P, U			DAC7624PB, UB DAC7625PB, UB			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
<b>ACCURACY</b>								
Linearity Error <sup>(1)</sup>	$V_{SS} = 0\text{V}$ or $-5\text{V}$			$\pm 2$			$\pm 1$	LSB <sup>(2)</sup>
Linearity Matching <sup>(3)</sup>	$V_{SS} = 0\text{V}$ or $-5\text{V}$			$\pm 2$			$\pm 1$	LSB
Differential Linearity Error	$V_{SS} = 0\text{V}$ or $-5\text{V}$			$\pm 1$			$\pm 1$	LSB
Monotonicity	$T_{MIN}$ to $T_{MAX}$	12			*			Bits
Zero-Scale Error	Code = $000_H$			$\pm 4$			*	LSB
Zero-Scale Drift			2	5		*	*	ppm/ $^{\circ}\text{C}$
Zero-Scale Matching <sup>(3)</sup>				$\pm 2$			$\pm 1$	LSB
Full-Scale Error	Code = $FFF_H$			$\pm 4$			*	LS
Full-Scale Matching <sup>(3)</sup>				$\pm 2$			$\pm 1$	LSB
Zero-Scale Error	Code = $00A_H$ , $V_{SS} = 0\text{V}$			$\pm 8$			*	LSB
Zero-Scale Drift	$V_{SS} = 0\text{V}$		5	10		*	*	ppm/ $^{\circ}\text{C}$
Zero-Scale Matching <sup>(3)</sup>	$V_{SS} = 0\text{V}$			$\pm 4$			$\pm 2$	LSB
Full-Scale Error	Code = $FFF_H$ , $V_{SS} = 0\text{V}$			$\pm 8$			*	LSB
Full-Scale Matching <sup>(3)</sup>	$V_{SS} = 0\text{V}$			$\pm 4$			$\pm 2$	LSB
Power Supply Rejection			30			*		ppm/V
<b>ANALOG OUTPUT</b>								
Voltage Output <sup>(4)</sup>	$V_{REFL} = 0\text{V}$ , $V_{SS} = 0\text{V}$ $V_{SS} = -5\text{V}$	0 $V_{REFL}$ $-1.25$		$V_{REFH}$ $V_{REFH}$ $+1.25$	*		*	V V mA
Output Current			100			*	*	pF
Load Capacitance	No Oscillation		+5, -120 Momentary			*	*	mA
Short-Circuit Current						*	*	
Short-Circuit Duration						*	*	
<b>REFERENCE INPUT</b>								
$V_{REFH}$ Input Range	$V_{SS} = 0\text{V}$ or $-5\text{V}$	$V_{REFL} + 1.25$		+2.5	*		*	V
$V_{REFL}$ Input Range	$V_{SS} = 0\text{V}$	0		$V_{REFH} - 1.25$	*		*	V
$V_{REFL}$ Input Range	$V_{SS} = -5\text{V}$	-2.5		$V_{REFH} - 1.25$	*		*	V
<b>DYNAMIC PERFORMANCE</b>								
Settling Time <sup>(5)</sup>	To $\pm 0.012\%$		5	10		*	*	$\mu\text{s}$
Channel-to-Channel Crosstalk	Full-Scale Step		0.25			*	*	LSB
Output Noise Voltage	On any other DAC 0Hz to 1MHz		40			*	*	nV/ $\sqrt{\text{Hz}}$
<b>DIGITAL INPUT/OUTPUT</b>								
Logic Family				TTL-Compatible CMOS		*		
Logic Levels						*		
$V_{IH}$	$I_{IH} \leq \pm 10\mu\text{A}$	2.4		$V_{DD} + 0.3$	*		*	V
$V_{IL}$	$I_{IL} \leq \pm 10\mu\text{A}$	-0.3		0.8	*		*	V
$V_{OH}$	$I_{OH} = -0.8\text{mA}$	3.6		$V_{DD}$	*		*	V
$V_{OL}$	$I_{OL} = 1.6\text{mA}$	0.0		0.4	*		*	V
Data Format				Straight Binary		*		
<b>POWER SUPPLY REQUIREMENTS</b>								
$V_{DD}$		4.75		5.25	*		*	V
$V_{SS}$		-5.25		-4.75	*		*	V
$I_{DD}$	If $V_{SS} \neq 0\text{V}$		1.5	1.9		*	*	mA
$I_{SS}$		-2.1	-1.6		*	*	*	mA
Power Dissipation	$V_{SS} = -5\text{V}$		15	20		*	*	mW
	$V_{SS} = 0\text{V}$		7.5	10		*	*	mW
<b>TEMPERATURE RANGE</b>								
Specified Performance	DAC7624P, U, PB, UB DAC7625P, U, PB, UB	-40		+85	*		*	$^{\circ}\text{C}$

NOTES: (1) If  $V_{SS} = 0\text{V}$ , specification applies at code  $00A_H$  and above. (2) LSB means Least Significant Bit, when  $V_{REFH}$  equals  $+2.5\text{V}$  and  $V_{REFL}$  equals  $-2.5\text{V}$ , then one LSB equals  $1.22\text{mV}$ . (3) All DAC outputs will match within the specified error band. (4) Ideal output voltage, does not take into account zero or full-scale error. (5) If  $V_{SS} = -5\text{V}$ , full-scale 5V step. If  $V_{SS} = 0\text{V}$ , full-scale positive 2.5V step and negative step from code  $FFF_H$  to  $00A_H$ .

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## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

$V_{DD}$ to $V_{SS}$ .....	-0.3V to 11V
$V_{DD}$ to GND .....	-0.3V to 5.5V
$V_{REFL}$ to $V_{SS}$ .....	-0.3V to ( $V_{DD} - V_{SS}$ )
$V_{DD}$ to $V_{REFH}$ .....	-0.3V to ( $V_{DD} - V_{SS}$ )
$V_{REFH}$ to $V_{REFL}$ .....	-0.3V to ( $V_{DD} - V_{SS}$ )
Digital Input Voltage to GND .....	-0.3V to $V_{DD} + 0.3V$
Digital Output Voltage to GND .....	-0.3V to $V_{DD} + 0.3V$
Maximum Junction Temperature .....	+150°C
Operating Temperature Range .....	-40°C to +85°C
Storage Temperature Range .....	-65°C to +150°C
Lead Temperature (soldering, 10s) .....	+300°C

NOTE: (1) Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum conditions for extended periods may affect device reliability.



## ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

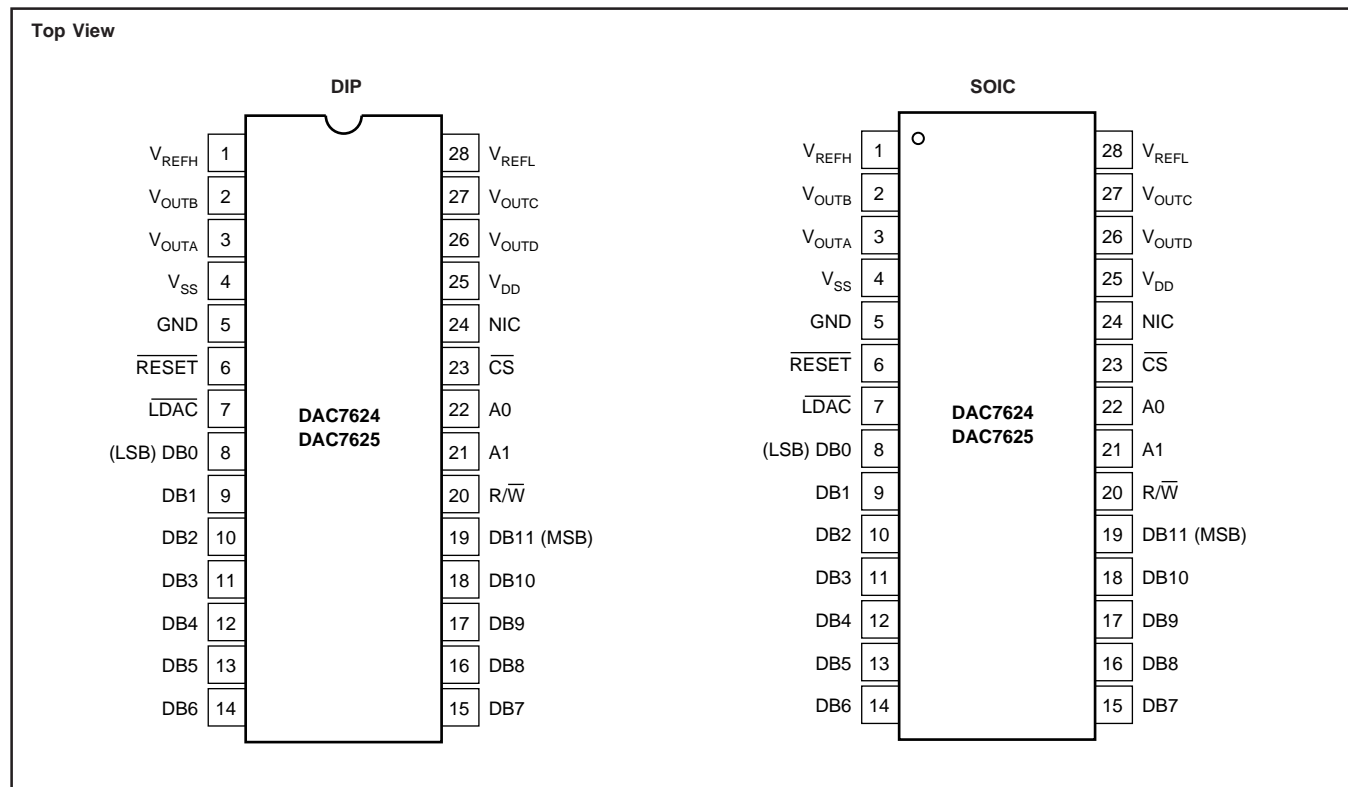
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## PACKAGE/ORDERING INFORMATION

PRODUCT	MAXIMUM LINEARITY ERROR (LSB)	MAXIMUM DIFFERENTIAL LINEARITY ERROR (LSB)	SPECIFICATION TEMPERATURE RANGE	PACKAGE	PACKAGE DRAWING NUMBER <sup>(1)</sup>
DAC7624P	±2	±1	-40°C to +85°C	28-Pin Plastic DIP	215
DAC7624U	±2	±1	-40°C to +85°C	28-Lead SOIC	217
DAC7624PB	±1	±1	-40°C to +85°C	28-Pin Plastic DIP	215
DAC7624UB	±1	±1	-40°C to +85°C	28-Lead SOIC	217
DAC7625P	±2	±1	-40°C to +85°C	28-Pin Plastic DIP	215
DAC7625U	±2	±1	-40°C to +85°C	28-Lead SOIC	217
DAC7625PB	±1	±1	-40°C to +85°C	28-Pin Plastic DIP	215
DAC7625UB	±1	±1	-40°C to +85°C	28-Lead SOIC	217

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.

## PIN CONFIGURATIONS

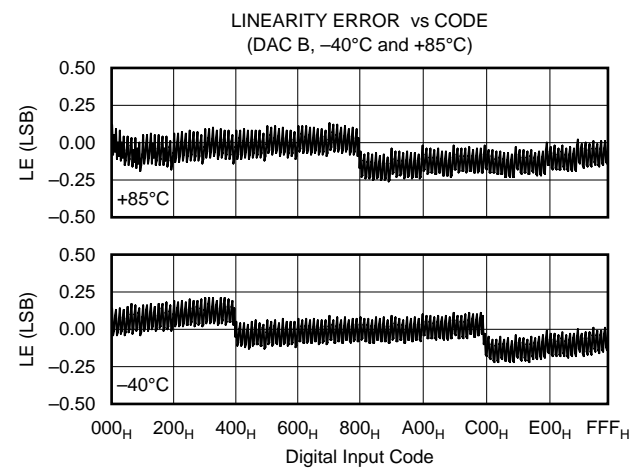
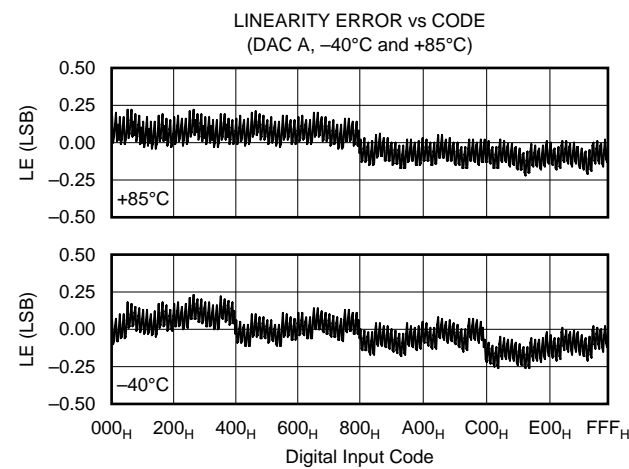
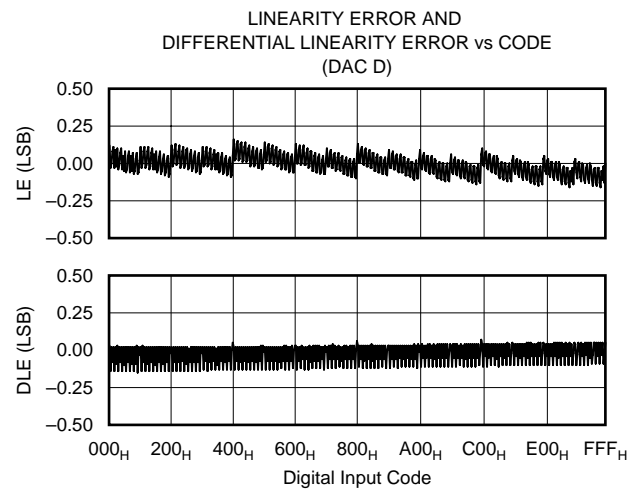
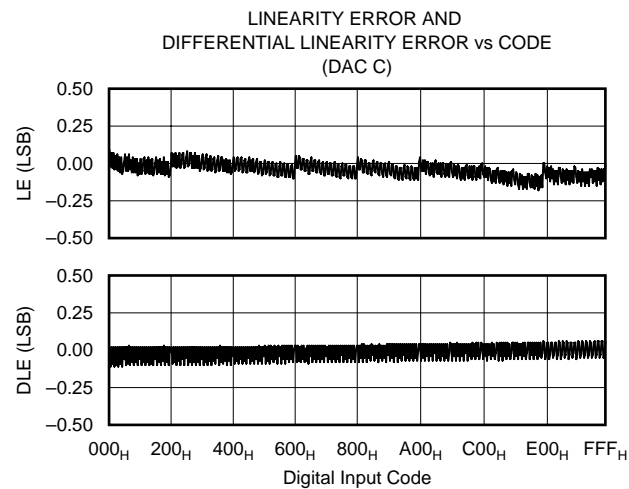
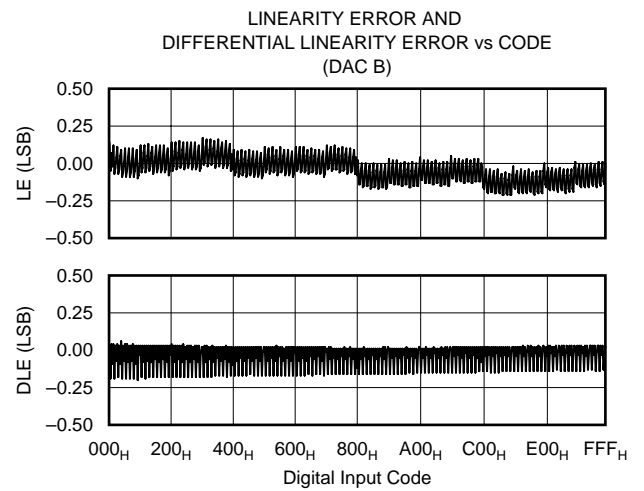
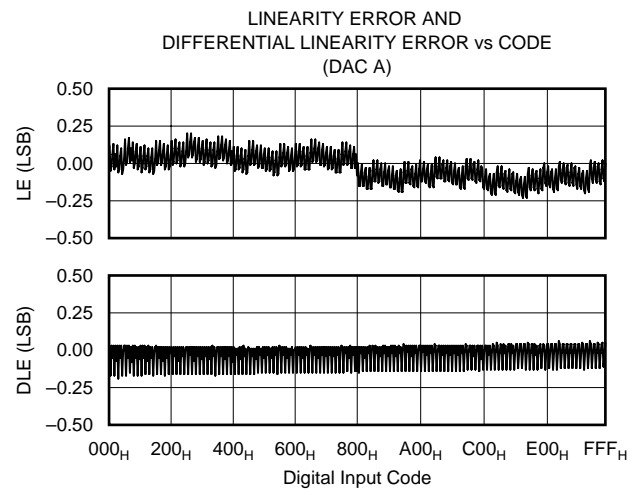


## PIN DESCRIPTIONS

PIN	NAME	DESCRIPTION
1	V <sub>REFH</sub>	Reference Input Voltage High. Sets maximum output voltage for all DACs.
2	V <sub>OUTB</sub>	DAC B Voltage Output.
3	V <sub>OUTA</sub>	DAC A Voltage Output.
4	V <sub>SS</sub>	Negative Analog Supply Voltage, 0V or -5V.
5	GND	Ground.
6	RESET	Asynchronous Reset Input. Sets DAC and input registers to either mid-scale (800 <sub>H</sub> , DAC7624) or zero-scale (000 <sub>H</sub> , DAC7625) when LOW.
7	LDAC	Load DAC Input. All DAC Registers are transparent when LOW.
8	DB0	Data Bit 0. Least significant bit of 12-bit word.
9	DB1	Data Bit 1
10	DB2	Data Bit 2
11	DB3	Data Bit 3
12	DB4	Data Bit 4
13	DB5	Data Bit 5
14	DB6	Data Bit 6
15	DB7	Data Bit 7
16	DB8	Data Bit 8
17	DB9	Data Bit 9
18	DB10	Data Bit 10
19	DB11	Data Bit 11. Most significant bit of 12-bit word.
20	R/W	Read/Write Control Input (read = HIGH, write = LOW).
21	A1	Register/DAC Select (C or D = HIGH, A or B = LOW).
22	A0	Register/DAC Select (B or D = HIGH, A or C = LOW).
23	CS	Chip Select Input.
24	NIC	Not Internally Connected. Pin has no internal connection to the device.
25	V <sub>DD</sub>	Positive Analog Supply Voltage, +5V nominal.
26	V <sub>OUTD</sub>	DAC D Voltage Output.
27	V <sub>OUTC</sub>	DAC C Voltage Output.
28	V <sub>REFL</sub>	Reference Input Voltage Low. Sets minimum output voltage for all DACs.

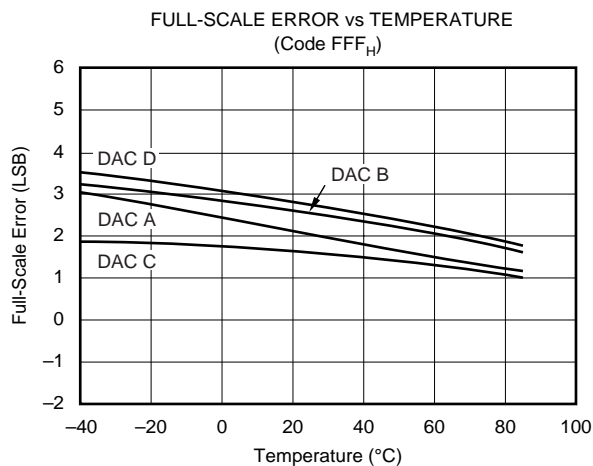
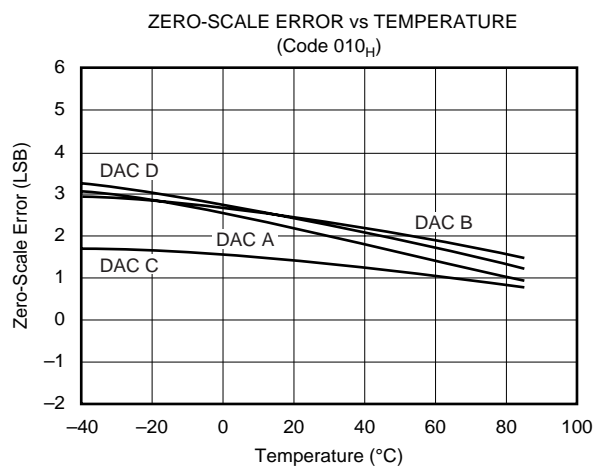
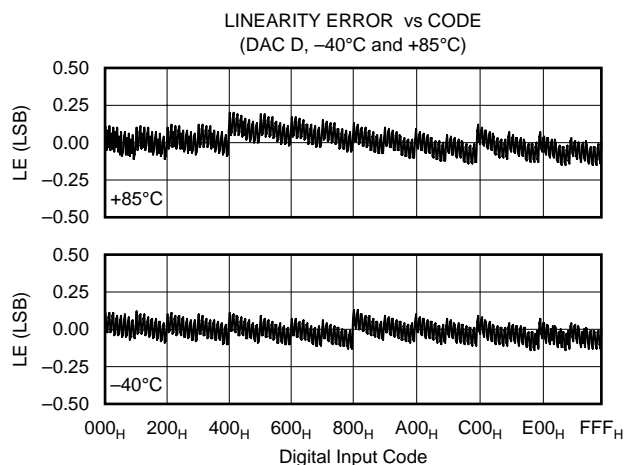
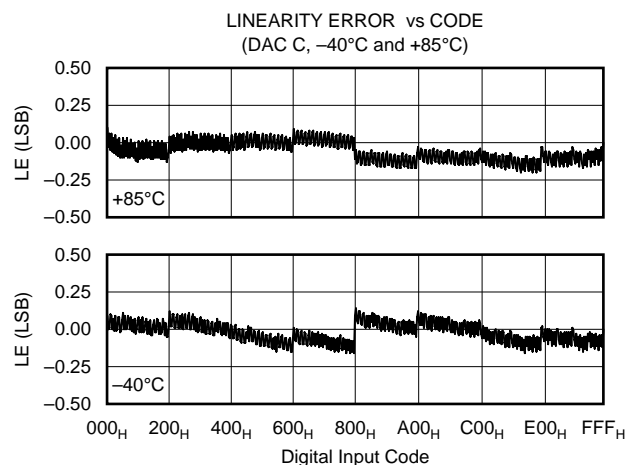
# TYPICAL PERFORMANCE CURVES: $V_{SS} = 0V$

At  $T_A = +25^\circ C$ ,  $V_{DD} = +5V$ ,  $V_{SS} = 0V$ ,  $V_{REFH} = +2.5V$ ,  $V_{REFL} = 0V$ , representative unit, unless otherwise specified.



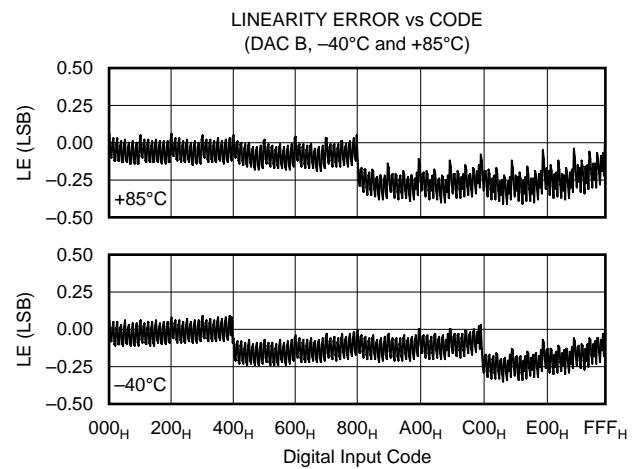
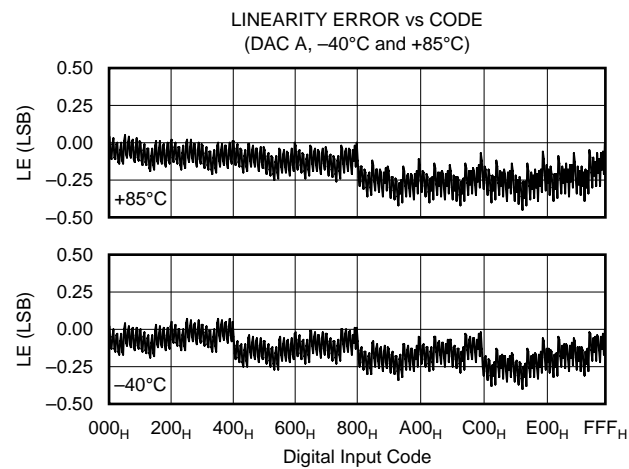
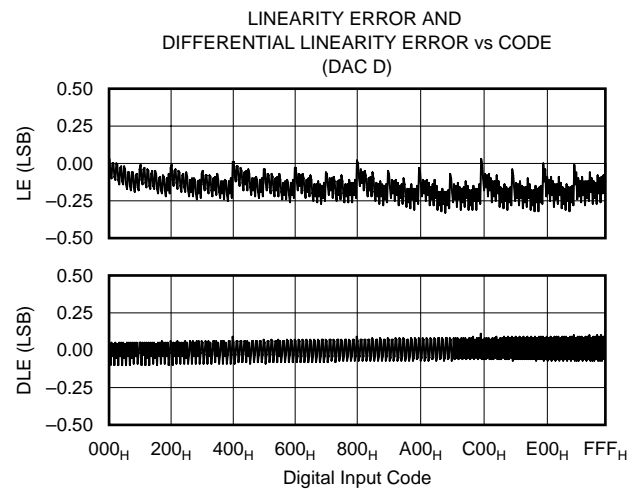
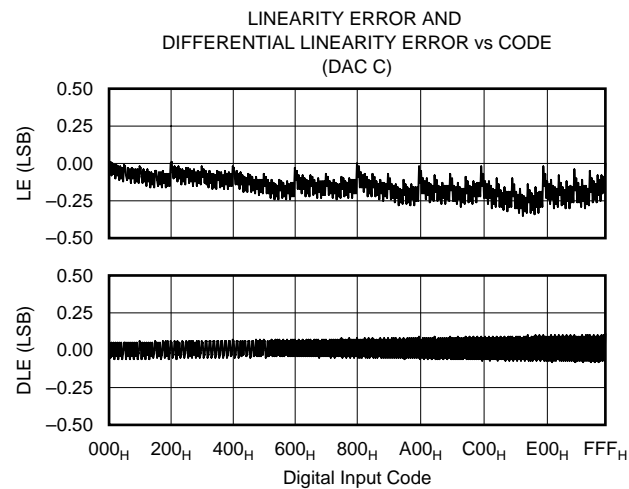
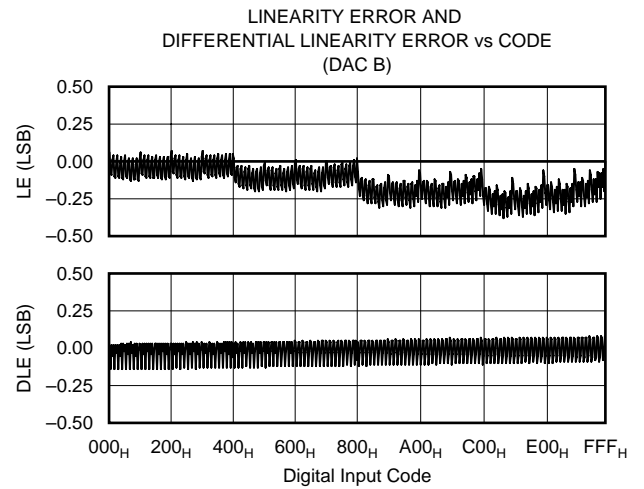
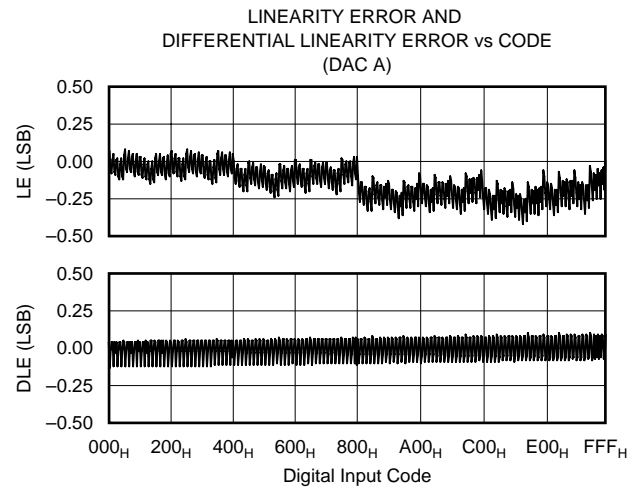
# TYPICAL PERFORMANCE CURVES: $V_{SS} = 0V$ (CONT)

At  $T_A = +25^\circ C$ ,  $V_{DD} = +5V$ ,  $V_{SS} = 0V$ ,  $V_{REFH} = +2.5V$ ,  $V_{REFL} = 0V$ , representative unit, unless otherwise specified.



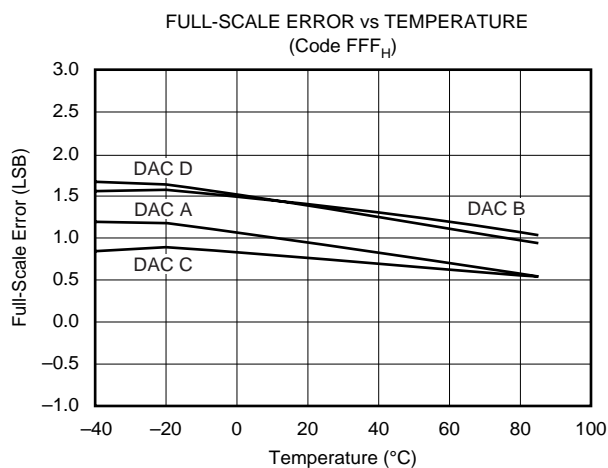
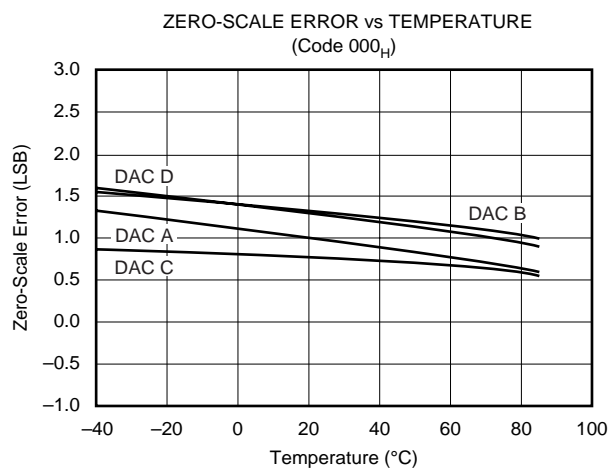
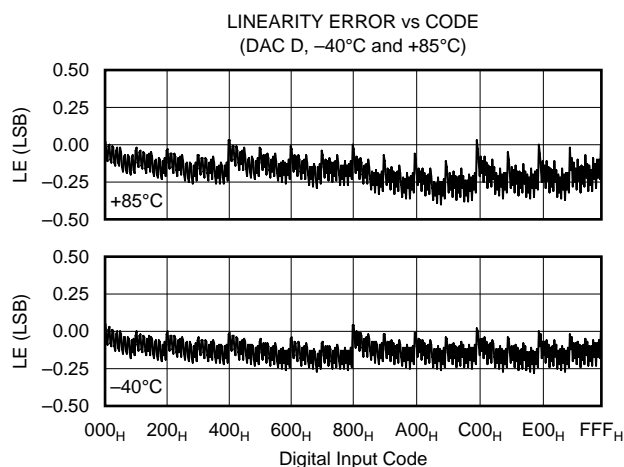
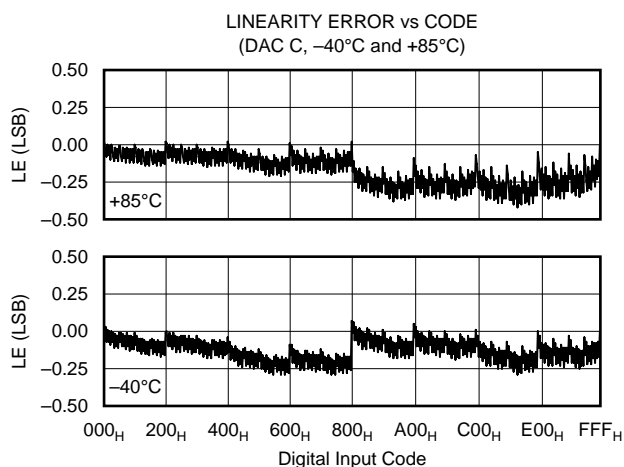
# TYPICAL PERFORMANCE CURVES: $V_{SS} = -5V$

At  $T_A = +25^\circ C$ ,  $V_{DD} = +5V$ ,  $V_{SS} = -5V$ ,  $V_{REFH} = +2.5V$ ,  $V_{REFL} = -2.5V$ , representative unit, unless otherwise specified.



# TYPICAL PERFORMANCE CURVES: $V_{SS} = -5V$ (CONT)

At  $T_A = +25^\circ C$ ,  $V_{DD} = +5V$ ,  $V_{SS} = -5V$ ,  $V_{REFH} = +2.5V$ ,  $V_{REFL} = -2.5V$ , representative unit, unless otherwise specified.





The DAC7624 and DAC7625 are quad, voltage output, 12-bit digital-to-analog converters (DACs). The architecture is a classic R-2R ladder configuration followed by an operational amplifier that serves as a buffer. Each DAC has its own R-2R ladder network and output op-amp, but all share the reference voltage inputs. The minimum voltage output (“zero-scale”) and maximum voltage output (“full-scale”)

are set by the external voltage references ( $V_{\text{REFL}}$  and  $V_{\text{REFH}}$ , respectively). The digital input is a 12-bit parallel word and the DAC input registers offer a readback capability. The converters can be powered from a single +5V supply or a dual  $\pm 5\text{V}$  supply. Each device offers a reset function which immediately sets all DAC output voltages and DAC registers to mid-scale (DAC7624, code  $800_{\text{H}}$ ) or to zero-scale (DAC7625, code  $000_{\text{H}}$ ). See Figures 1 and 2 for the basic operation of the DAC7624/25.



## ANALOG OUTPUTS

When  $V_{SS} = -5V$  (dual supply operation), the output amplifier can swing to within 2.25V of the supply rails, guaranteed over the  $-40^{\circ}C$  to  $+85^{\circ}C$  temperature range. With  $V_{SS} = 0V$  (single-supply operation), the output can swing to ground. Note that the settling time of the output op-amp will be longer with voltages very near ground. Also, care must be taken when measuring the zero-scale error when  $V_{SS} = 0V$ . Since the output voltage cannot swing below ground, the output voltage may not change for the first few digital input codes (000<sub>H</sub>, 001<sub>H</sub>, 002<sub>H</sub>, etc.) if the output amplifier has a negative offset.

The behavior of the output amplifier can be critical in some applications. Under short circuit conditions (DAC output shorted to ground), the output amplifier can sink a great deal more current than it can source. See the specification table for more details concerning short circuit current.

## REFERENCE INPUTS

The reference inputs,  $V_{REFL}$  and  $V_{REFH}$ , can be any voltage between  $V_{SS}+2.25V$  and  $V_{DD}-2.25V$  provided that  $V_{REFH}$  is at least 1.25V greater than  $V_{REFL}$ . The minimum output of each DAC is equal to  $V_{REFL}$  plus a small offset voltage (essentially, the offset of the output op-amp). The maximum output is equal to  $V_{REFH}$  plus a similar offset voltage. Note that  $V_{SS}$  (the negative power supply) must either be connected to ground or must be in the range of  $-4.75V$  to  $-5.25V$ . The voltage on  $V_{SS}$  sets several bias points within the converter, if  $V_{SS}$  is not in one of these two configurations, the bias values may be in error and proper operation of the device is not guaranteed.

The current into the  $V_{REFH}$  input depends on the DAC output voltages and can vary from a few microamps to approximately 0.5 milliamp. The  $V_{REFH}$  source will not be required to sink current, only source it. Bypassing the reference voltage or voltages with at least a 0.1uF capacitor placed as close to the DAC7624/25 package is strongly recommended.

## DIGITAL INTERFACE

Table I shows the basic control logic for the DAC7624/25. Note that each internal register is level triggered and not edge triggered. When the appropriate signal is LOW, the register becomes transparent. When this signal is returned HIGH, the digital word currently in the register is latched. The first set of registers (the Input Registers) are triggered via the A0, A1, R/W, and  $\overline{CS}$  inputs. Only one of these registers is transparent at any given time. The second set of registers (the DAC Registers) are all transparent when  $\overline{LDAC}$  input is pulled LOW.

Each DAC can be updated independently by writing to the appropriate Input Register and then updating the DAC Register. Alternatively, the entire DAC Register set can be configured as always transparent by keeping  $\overline{LDAC}$  LOW—the DAC update will occur when the Input Register is written.

The double buffered architecture is mainly designed so that each DAC Input Register can be written at any time and then all DAC voltages updated simultaneously by pulling  $\overline{LDAC}$  LOW. It also allows a DAC Input Register to be written to at any point and the DAC voltage to be synchronously changed via a trigger signal connected to  $\overline{LDAC}$ .

A1	A0	R/W	$\overline{CS}$	$\overline{RESET}$	$\overline{LDAC}$	SELECTED INPUT REGISTER	STATE OF SELECTED INPUT REGISTER	STATE OF ALL DAC REGISTERS
L <sup>(1)</sup>	L	L	L	H <sup>(2)</sup>	L	A	Transparent	Transparent
L	H	L	L	H	L	B	Transparent	Transparent
H	L	L	L	H	L	C	Transparent	Transparent
H	H	L	L	H	L	D	Transparent	Transparent
L	L	L	L	H	H	A	Transparent	Latched
L	H	L	L	H	H	B	Transparent	Latched
H	L	L	L	H	H	C	Transparent	Latched
H	H	L	L	H	H	D	Transparent	Latched
L	L	H	L	H	H	A	Readback	Latched
L	H	H	L	H	H	B	Readback	Latched
H	L	H	L	H	H	C	Readback	Latched
H	H	H	L	H	H	D	Readback	Latched
X <sup>(3)</sup>	X	X	H	H	L	NONE	(All Latched)	Transparent
X	X	X	H	H	H	NONE	(All Latched)	Latched
X	X	X	X	L	X	ALL	Reset <sup>(4)</sup>	Reset <sup>(4)</sup>

NOTES: (1) L = Logic LOW. (2) H = Logic HIGH. (3) X = Don't Care. (4) DAC7624 resets to 800<sub>H</sub>, DAC7625 resets to 000<sub>H</sub>. When  $\overline{RESET}$  rises, all registers that are in their latched state retain the reset value.

TABLE I. DAC7624 and DAC7625 Control Logic Truth Table.

## DIGITAL TIMING

Figure 3 and Table II provide detailed timing for the digital interface of the DAC7624 and DAC7625.

## DIGITAL INPUT CODING

The DAC7624 and DAC7625 input data is in straight binary format. The output voltage is given by the following equation:

$$V_{OUT} = V_{REFL} + \frac{(V_{REFH} - V_{REFL}) \cdot N}{4096}$$

where N is the digital input code. This equation does not include the effects of offset (zero-scale) or gain (full-scale) errors.

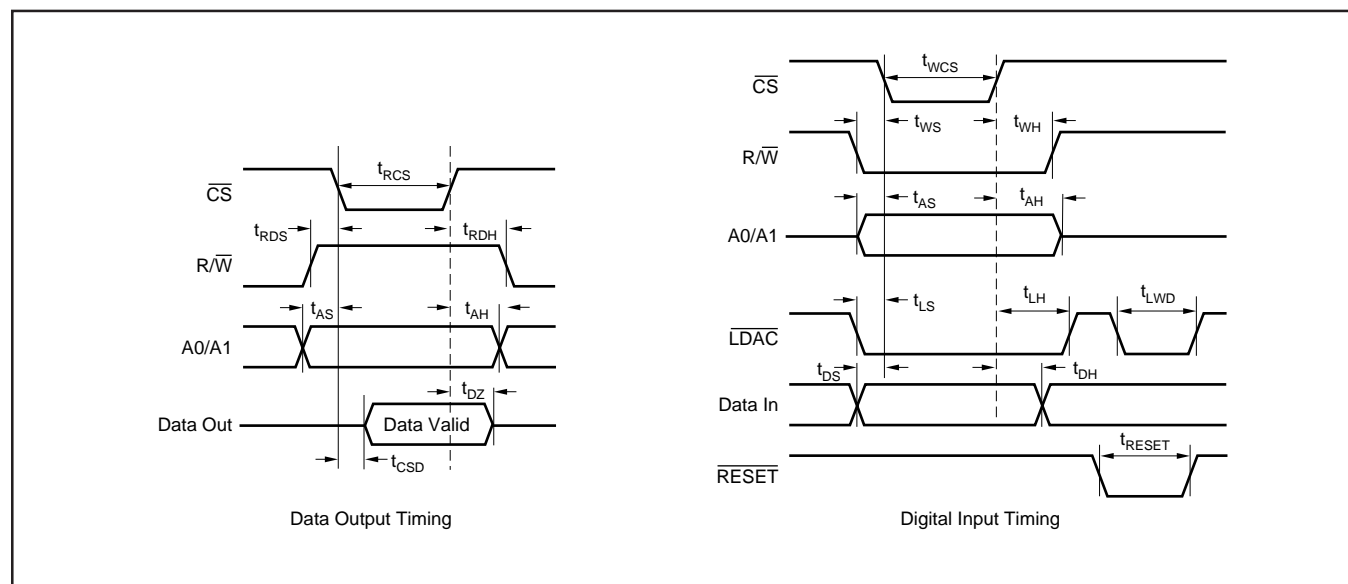


FIGURE 3. Digital Input and Output Timing.

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNITS
$t_{RCS}$	$\overline{CS}$ LOW for Read	200			ns
$t_{RDS}$	$R/\overline{W}$ HIGH to $\overline{CS}$ LOW	10			ns
$t_{RDH}$	$R/\overline{W}$ HIGH after $\overline{CS}$ HIGH	0			ns
$t_{DZ}$	$\overline{CS}$ HIGH to Data Bus in High Impedance		100		ns
$t_{CSD}$	$\overline{CS}$ LOW to Data Bus Valid		100	160	ns
$t_{WCS}$	$\overline{CS}$ LOW for Write	50			ns
$t_{WS}$	$R/\overline{W}$ LOW to $\overline{CS}$ LOW	0			ns
$t_{WH}$	$R/\overline{W}$ LOW after $\overline{CS}$ HIGH	0			ns
$t_{AS}$	Address Valid to $\overline{CS}$ LOW	0			ns
$t_{AH}$	Address Valid after $\overline{CS}$ HIGH	0			ns
$t_{LS}$	$\overline{LDAC}$ LOW to $\overline{CS}$ LOW	70			ns
$t_{LH}$	$\overline{LDAC}$ LOW after $\overline{CS}$ HIGH	50			ns
$t_{DS}$	Data Valid to $\overline{CS}$ LOW	0			ns
$t_{DH}$	Data Valid after $\overline{CS}$ HIGH	0			ns
$t_{LWD}$	$\overline{LDAC}$ LOW	50			ns
$t_{RESET}$	$\overline{RESET}$ LOW	50			ns

TABLE II. Timing Specifications ( $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ).

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